

# **DRAM**

## PowerSaver™ Mobile SDRAMS

High Performance with Low Power

#### ► ISSI Mobile SDRAM Product Features

#### Low Power:

Less power than standard SDRAMs with low standby current and self refresh options to maximize battery life and reduce heat

## • Wide Temperature Range:

Temperature range of -40°C to +85°C or -40°C to +105°C supports consumer, medical, automotive and industrial applications

#### • Product Portfolio:

Full range of Mobile SDR products, JEDEC ball-compatible with standard SDR products

## Long-Term Support:

ISSI fully committed to support legacy applications including x16/x32, 1.8V, 2.5V and 3.3V products

## **ISSI Mobile SDRAM Ordering Options**

Density	Org	Part Number
32M	2M x16	IS42XX16200D
	1M x32	IS42XX32100D
64M	4M x16	IS42XX16400M
	2M x32	IS42XX32200M
128M	8M x16	IS42XX16800H
	4M x32	IS42XX32400H
256M	16M x16	IS42XX16160K
	8M x32	IS42XX32800K
512M	32Mx16	IS42XX16320E
	16M x32	IS42XX32160E

Notes

XX: VM for Vdd = 1.8V, RM for Vdd = 2.5V, SM for Vdd = 3.3V. Production alternatives may be available. Contact ISSI for automotive grade options.

## **▶** Applications:

- Mobile Devices
   GPS/Navigation Systems
   IoT
   Digital Cameras
   Gaming Units
- Automotive
- Portable Medical Devices
- Industrial Applications



#### **ISSI Mobile SDRAM Features**

	Features	Benefits
Densities	16Mb - 512Mb (SDR)	Support legacy applications as well as new designs. Mobile product is backward compatible with Standard Synchronous DRAM.
Configurations	x8, x16, and x32	Support applications from legacy 8-bit to 32-bit wide data bus designs
VDD	1.8V / 2.5V / 3.3V	Full range of VDD supported: enables direct replacement of standard SDRAMs
Speed Grade / Clock Frequency	Up to 166MHz	High-speed data frequencies with Mobile DRAMs, but lower power than standard products
Special Mobile Features	Temperature Compensated Self Refresh [TCSR]	Adjust refresh rate based on required ambient temperature to minimize power consumption
	Partial Array Self Refresh (PASR)	Eliminates unnecessary row activations; full, 1/2, 1/4, 1/8 and 1/16 array options
	Deep Power Down (DPD)	Provides a low power state when data retention is not required to maximize battery life
	Programmable Drive Strength (DS)	Adjusts output drive strength to actual bus loading to minimize power consumption; full, 1/2, and 1/4 drive strength options
Temperature Ranges	-40°C to +85°C (Industrial), -40°C to +105°C (Automotive, A2)	High performance for wide range of end markets / applications
Packages	BGA	Smaller footprint for space-critical designs
	Known Good Die (KGD)	Support die-level applications including MCP solutions

<sup>\*</sup> Featured in Mobile DDR product information materials.

#### **ISSI Mobile SDRAM Part Number Decoder**

